

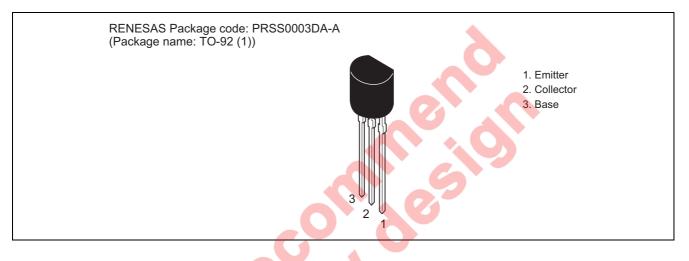
Silicon NPN Epitaxial

REJ03G0696-0200 (Previous ADE-208-1061) Rev.2.00 Aug.10.2005

Application

Low frequency amplifier

Outline



Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	55	V
Collector to emitter voltage	V _{CEO}	50	V
Emitter to base voltage	V _{EBO}	5	V
Collector current	Ι _C	100	mA
Collector power dissipation	Pc	200	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	–55 to +150	°C

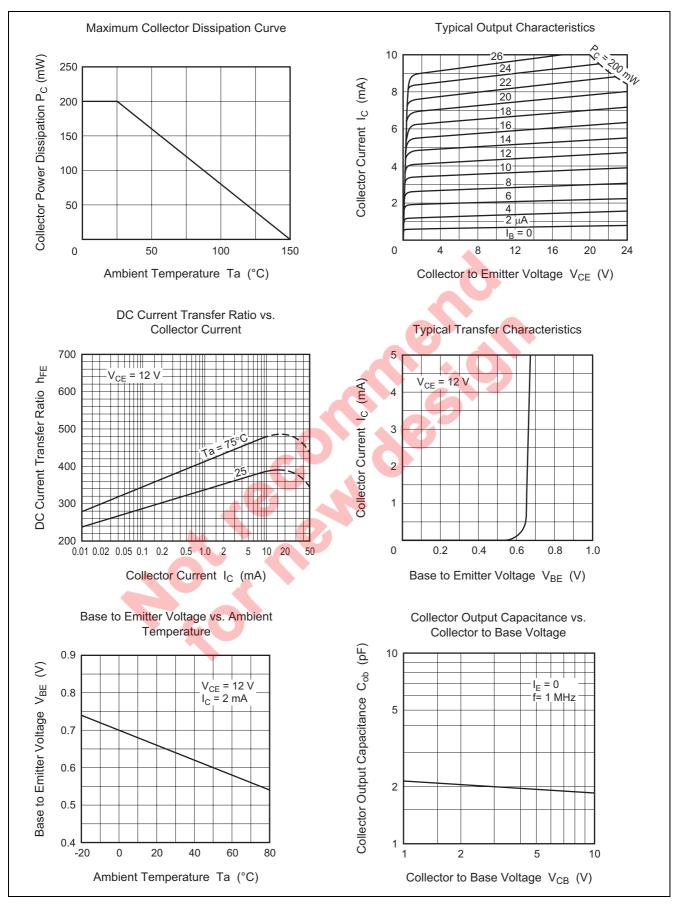


Electrical Characteristics

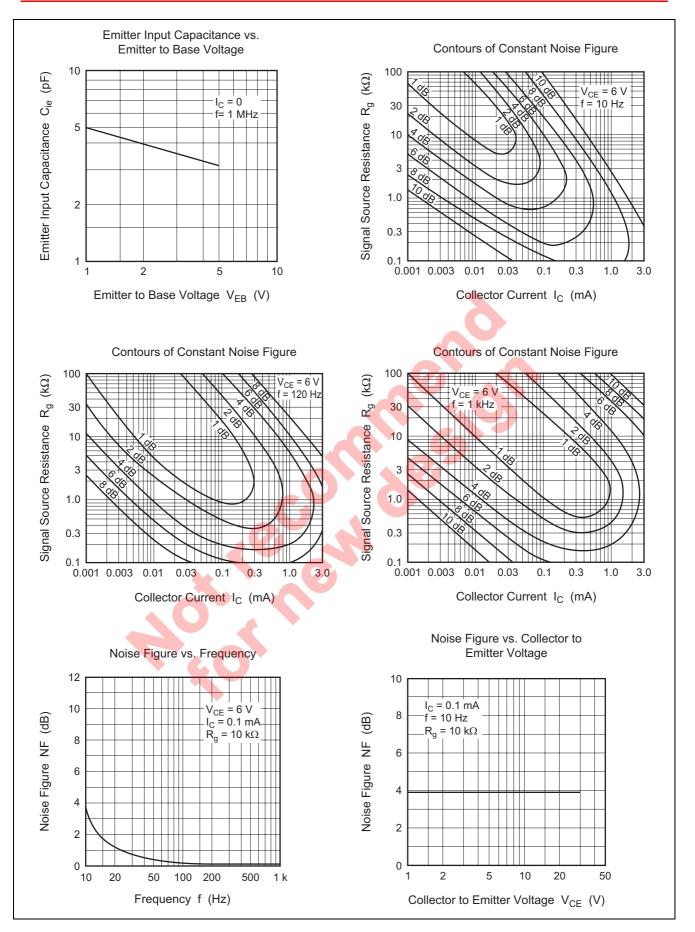
						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	55	_		V	$I_{C} = 10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	50	_		V	$I_C = 1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	5	—		V	$I_E = 10 \ \mu A, \ I_C = 0$
Collector cutoff current	I _{CBO}	—	—	0.5	μA	$V_{CB} = 18 V, I_E = 0$
Emitter cutoff current	I _{EBO}	—	—	0.5	μA	$V_{EB} = 2 V, I_C = 0$
DC current transfer ratio	h _{FE}	250	—	500		$V_{CE} = 12 \text{ V}, \text{ I}_{C} = 2 \text{ mA}$
Base to emitter voltage	V_{BE}	—	—	0.75	V	$V_{CE} = 12 \text{ V}, \text{ I}_{C} = 2 \text{ mA}$
Collector to emitter saturation voltage	V _{CE(sat)}	—	—	0.2	V	$I_{C} = 10 \text{ mA}, I_{B} = 1 \text{ mA}$
Gain bandwidth product	f⊤	_	230		MHz	$V_{CE} = 12 \text{ V}, I_C = 2 \text{ mA}$
Collector output capacitance	Cob		1.8	3.5	pF	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$



Main Characteristics





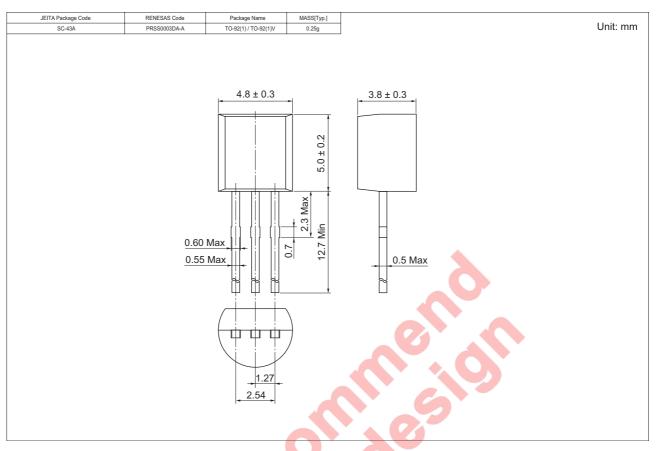








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SC2309DTZ-E	2500	Hold Box, Radial Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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Renesas Technology Malaysia Sdn. Bhd.

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